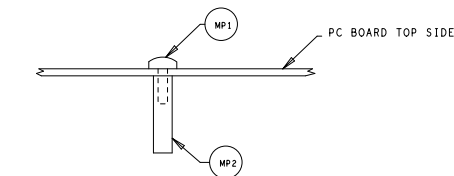


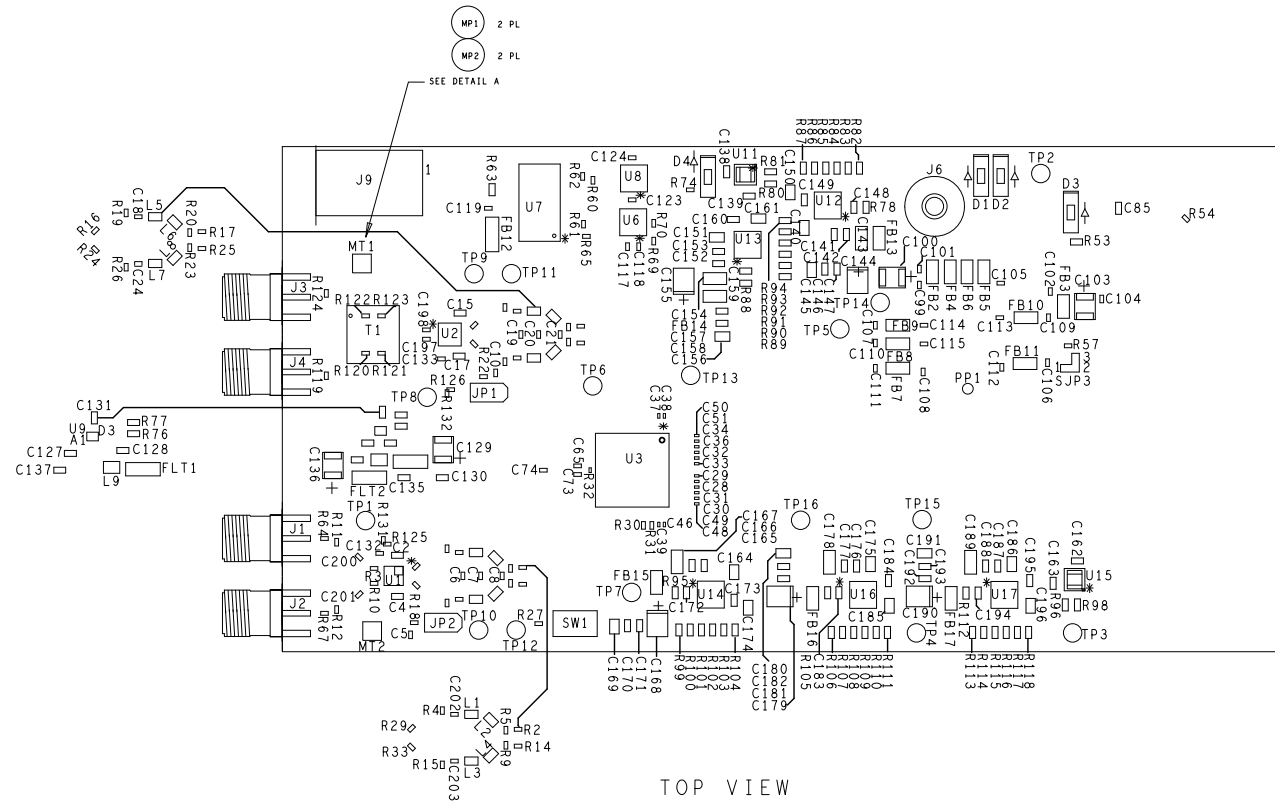
THIS DRAWING IS INTENDED TO HELP IN THE ASSEMBLY OF THE DESIGN.

ZONE		LTR		REVISIONS		DATE	APPROVED
				DESCRIPTION			

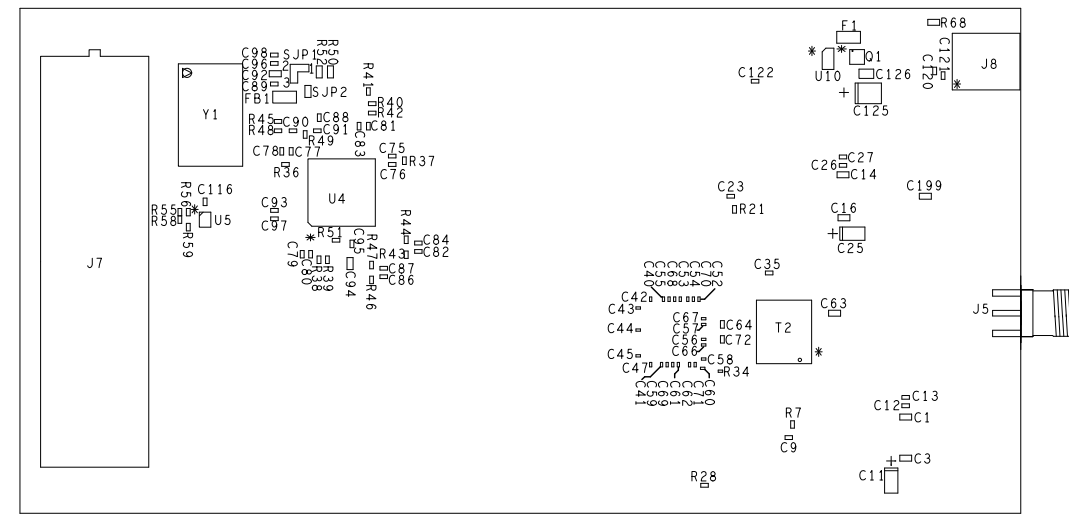
- REFER TO ODB++ FILE FOR SPECIFIC COMPONENT LOCATION INFORMATION.
- USE WATER SOLUBLE FLUX DURING BOARD ASSEMBLY. ASSEMBLY MUST BE RoHS COMPLIANT AND LEAD FREE.



DETAIL A (SIDE VIEW) - NO SCALE
INSTALL SPACERS (YY) AND SCREWS (XX) AS SHOWN.



TOP VIEW



BOTTOM VIEW

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES +/- .XX +/- .01 +/- +/- .XXX +/- .005 +/-	CONTRACT NO.		TEXAS INSTRUMENTS INC.	
	APPROVALS	DATE	ASSEMBLY DRAWING TSW54J60 EVM	
MATERIAL	DRAWN JV SMITH	04-10-15		
SEE NOTE 5	ENGR J SETON	04-10-15	SIZE	CODE IDENT NO. DRAWING NO.
FINISH			B	B
DO NOT SCALE DRAWING			SCALE 2:1	SHEET 1 OF 1

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